

N-Channel Enhancement Mode MOSFET

1. Product Information

1.1 Features

- ☑ Surface-mounted package
- ☑ Advanced trench cell design
- ☑ Super Trench

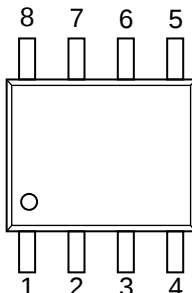
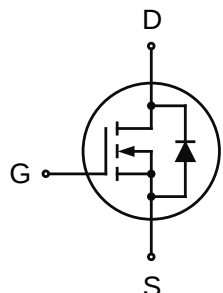
1.2 Applications

- ☑ LCD TV appliances
- ☑ High power inverter system
- ☑ LCDM appliances

1.3 Quick reference

- ☑ $BV \geq 40V$
- ☑ $R_{DS(ON)} \leq 8.0m\Omega @ V_{GS} = 10V$
- ☑ $P_{tot} \leq 2W$
- ☑ $R_{DS(ON)} \leq 13.5m\Omega @ V_{GS} = 4.5V$
- ☑ $I_D \leq 12A$

2. Pin Description

Pin	Description	Simplified Outline	Symbol
1,2,3	Source	 Top View SOP8	
4	Gate		
5,6,7,8	Drain		

3. Limiting Values

Symbol	Parameter	Conditions	Min	Max	Unit
V_{DS}	Drain-Source Voltage	$T_C=25^{\circ}C$	40	-	V
V_{GS}	Gate-Source Voltage	$T_C=25^{\circ}C$	-	± 20	V
I_D^*	Drain Current	$T_C=25^{\circ}C, V_{GS}=10V$	-	11	A
I_{DM}^*	Pulsed Source Current	$T_C=25^{\circ}C, V_{GS}=10V$	-	44	A
P_{tot}^*	Total Power Dissipation	$T_C=25^{\circ}C$	-	2	W
T_{stg}	Storage Temperature		-55	150	$^{\circ}C$
T_J	Junction Temperature		-	150	$^{\circ}C$
$R_{\theta JA}^*$	Thermal Resistance-Junction to Ambient		-	56	$^{\circ}C/W$

Notes:

* Surface Mounted on 1 in² pad area, $t \leq 10$ sec

** Pulse width $\leq 10\mu s$, duty cycle $\leq 1\%$

*** Limited by bonding wire

4. Marking Information

Product Name	Marking
KJ0804S	0804 YWWXXX YWWXXX: Date Code

5. Ordering Code

Product Name	Package	Reel Size	Tape width	Quantity	Note
KJ0804S	SOP8	-	-	3000	

Note: KUAIJIEIXIN defines "Green" as lead-free (RoHS compliant) and halogen free (Br or Cl does not exceed 900 ppm by weight in homogeneous material and total of Br and Cl does not exceed 1500 ppm by weight; Follow IEC 61249-2-21 and IPC/JEDEC J-STD-020C)

**快捷****KJ0804S****6. Electrical Characteristics** ($T_A=25^{\circ}\text{C}$ Unless Otherwise Noted)

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
Static Characteristics						
BV _{DSS}	Drain-Source Breakdown Voltage	V _{GS} =0V, I _{DS} =250μA	40	-	-	V
V _{GS(th)}	Gate Threshold Voltage	V _{DS} =V _{GS} , I _{DS} =250μA	1.3	-	2.5	V
I _{DSS}	Drain Leakage Current	V _{DS} =36V, V _{GS} =0V	-	-	1	μA
I _{GSS}	Gate Leakage Current	V _{GS} =0V, V _{GS} =±20V	-	-	±10	uA
R _{DS(ON)} ^a	On-State Resistance	V _{GS} =10V, I _{DS} =10A	-	7.5	8	mΩ
		V _{GS} =4.5V, I _{DS} =5A	-	12.5	13.5	
Diode Characteristics						
V _{SD} ^a	Diode Forward Voltage	I _{SD} =10A, V _{GS} =0V	-	-	1.3	V
t _{rr}	Reverse Recovery Time	I _{DS} =10A, V _{GS} =0V, dI _{SD} /dt=100A/μs	-	19	-	ns
Q _{rr}	Reverse Recovery Charge		-	10	-	nC
Dynamic Characteristics ^b						
C _{iss}	Input Capacitance	V _{GS} =0V, V _{DS} =22.5V, Frequency=1MHz	-	658	-	pF
C _{oss}	Output Capacitance		-	142	-	
C _{rss}	Reverse Transfer Capacitance		-	9	-	
t _{d(on)}	Turn-on Delay Time	V _{DS} =22.5V, V _{GEN} =10V, R _G =3.9Ω, R _L =2.25Ω, I _{DS} =10A	-	6	-	ns
t _r	Turn-on Rise Time		-	23	-	
t _{d(off)}	Turn-off Delay Time		-	17	-	
t _f	Turn-off Fall Time		-	19	-	
Gate Charge Characteristics ^b						
Q _g	Total Gate Charge	V _{DS} =22.5V, V _{GS} =10V, I _{DS} =10A	-	15	-	nC
Q _{gs}	Gate-Source Charge		-	3	-	
Q _{gd}	Gate-Drain Charge		-	3.1	-	

Notes:

a. Pulse test; pulse width $\leq 300\mu s$, duty cycle $\leq 2\%$

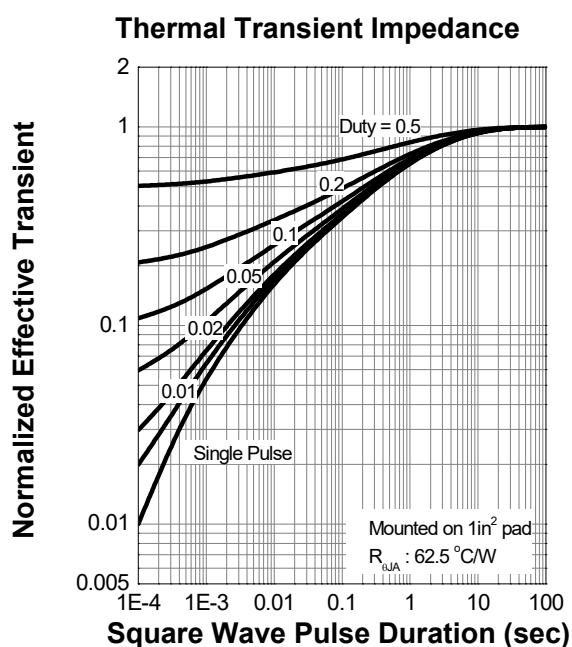
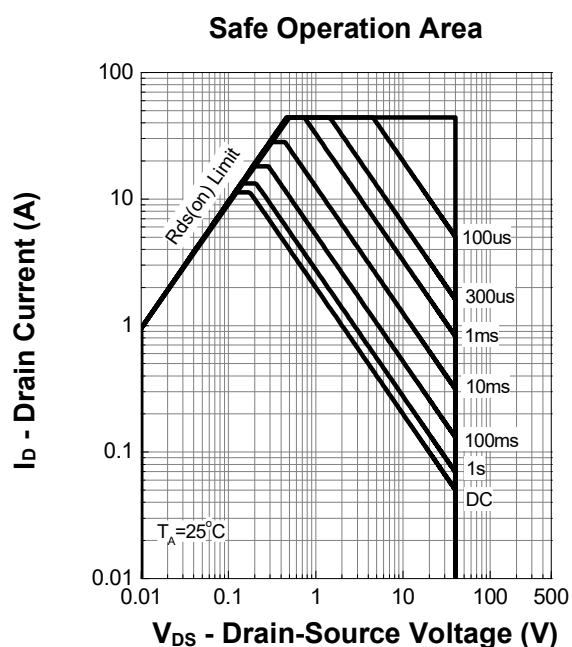
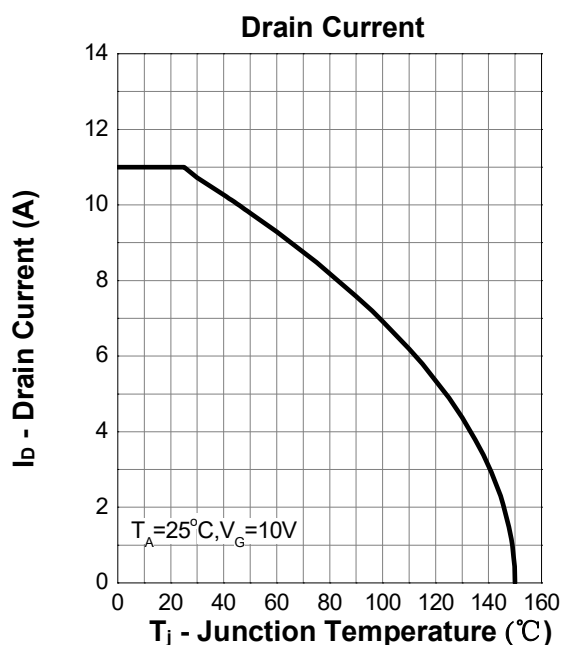
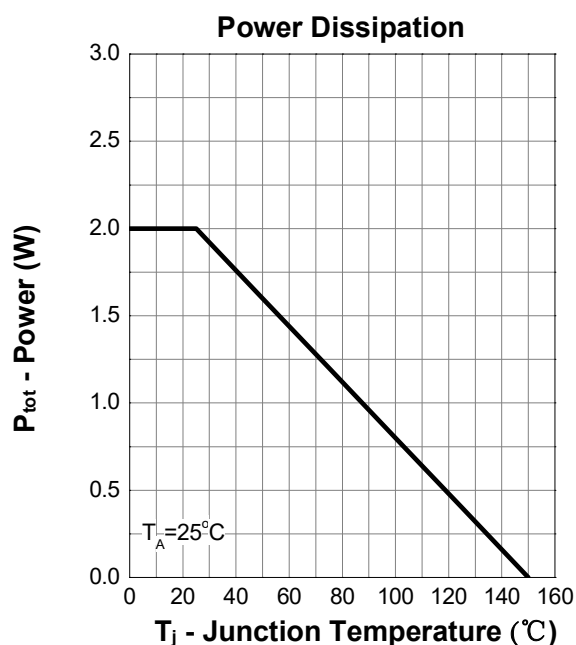
b. Guaranteed by design, not subject to production testing



快捷恒

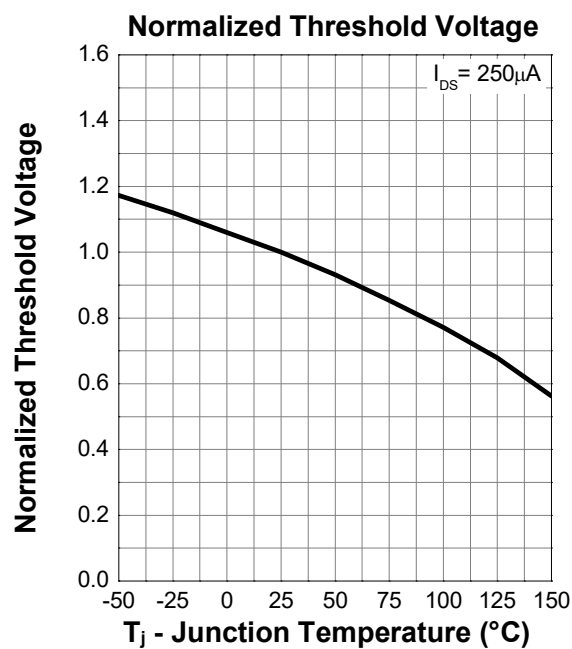
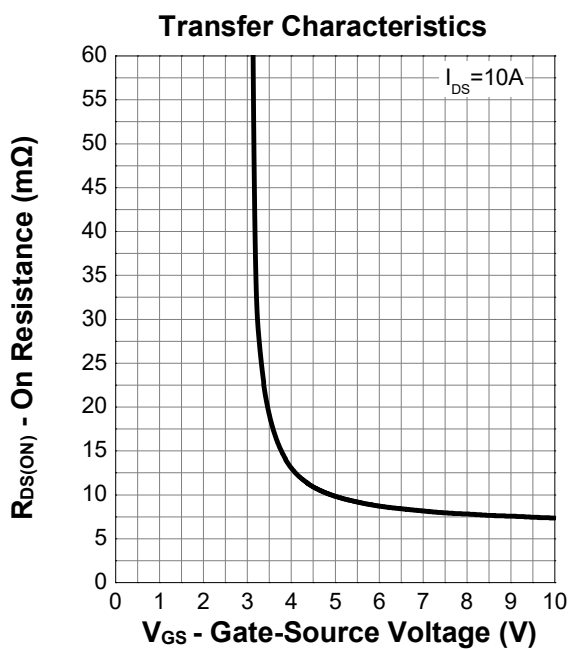
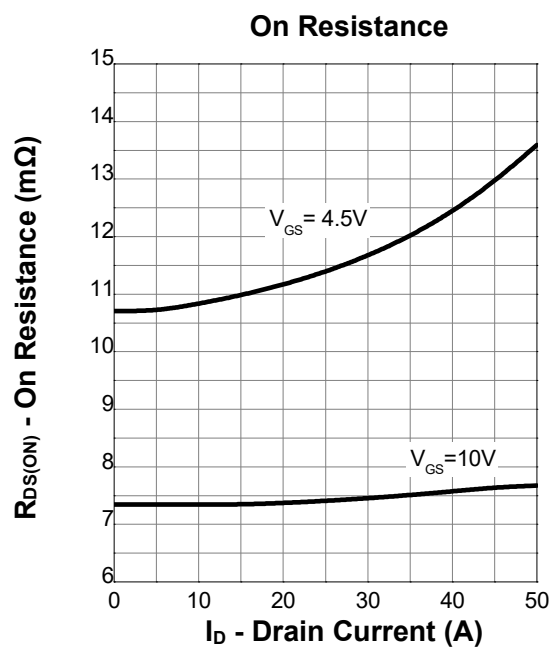
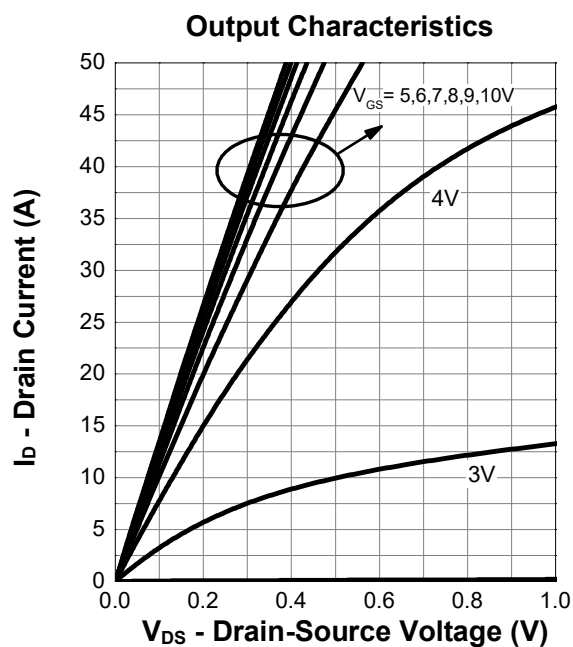
KJ0804S

7. Typical Characteristics





7. Typical Characteristics (cont.)

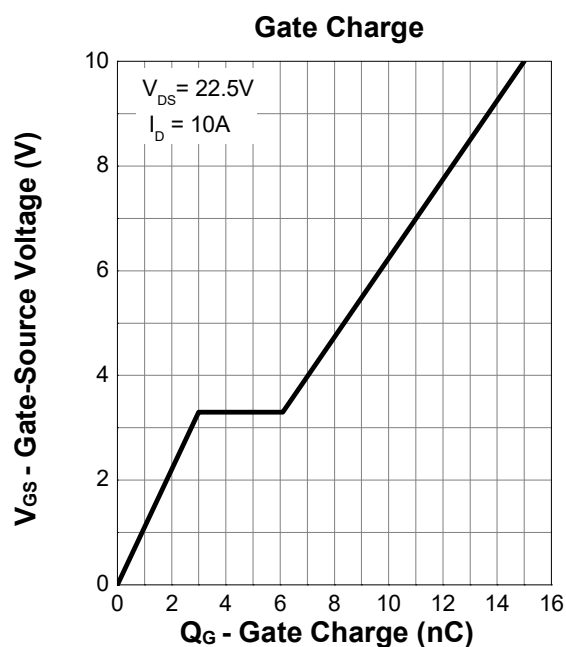
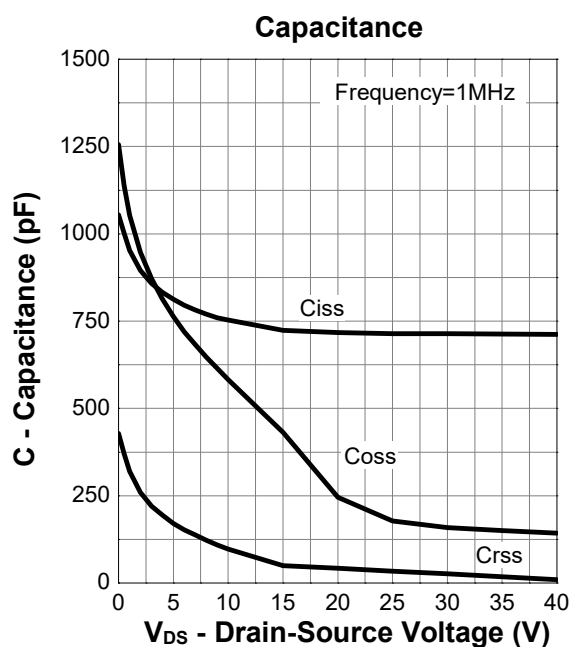
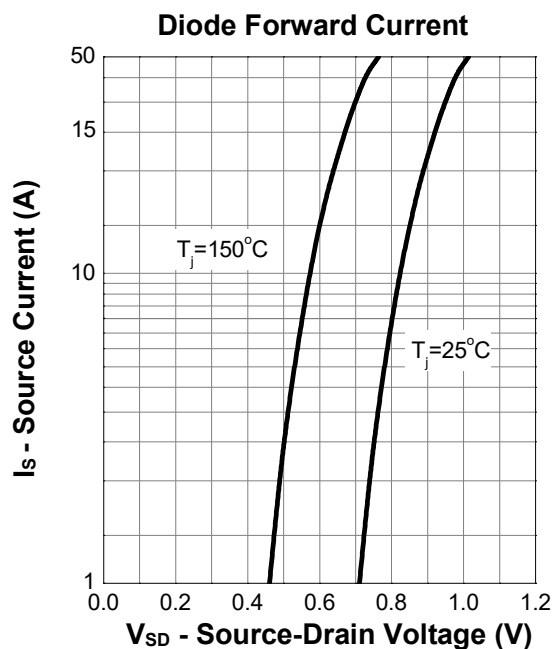
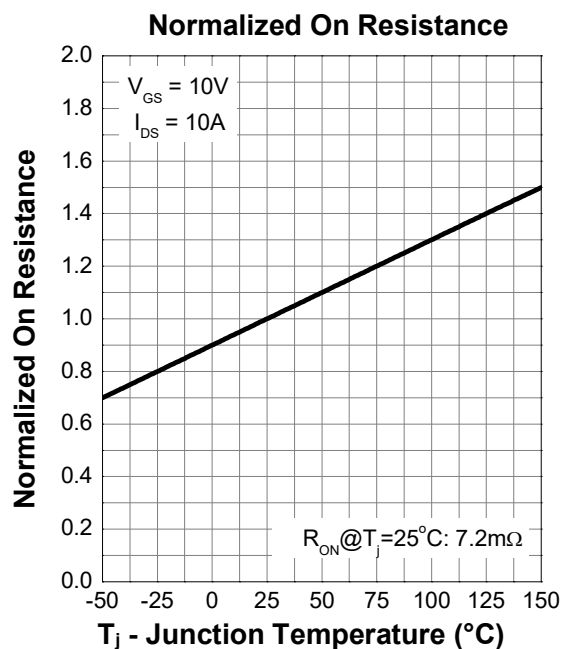




快捷通

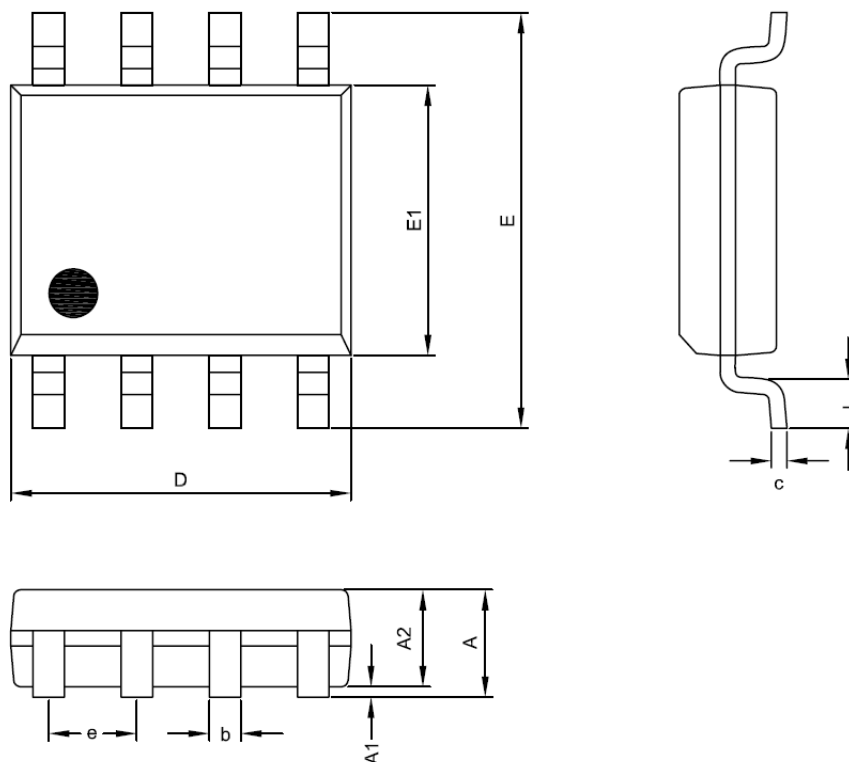
KJ0804S

7. Typical Characteristics (cont.)



8. Package Dimensions

SOP8 Package



Symbol	Dimensions In Millimeters	
	MIN.	MAX.
A	1.35	1.75
A1	0.00	0.25
A2	1.15	1.50
D	4.80	5.00
E	5.80	6.20
E1	3.80	4.00
c	0.19	0.27
b	0.33	0.53
e	1.27 BSC	
L	0.40	1.27